



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

App. No. : 10/790,786
Applicant : Jingyu Lian, et al.
Filed : March 3, 2004
TC/A.U. : Not Yet Assigned
Examiner : Unknown
Confirmation No. : 4369
Docket No. : 0928.0067C
Customer No. : 27896
Title : Method for Forming A (III) Oriented BSTO Thin Film Layer for High Dielectric Constant Capacitors

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PETITION UNDER 37 C.F.R. 1.47(a)

Sir:

Applicants Jingyu Lian, David Kotecki, Robert Laibowitz, Katherine Saenger, Chenting Lin, Nicolas Nagel, Yunyu Wang, Satish D. Athavale, and Thomas Shaw hereby petition the Commissioner, through their attorney of record, that the above-identified patent application be accepted for examination pursuant to 35 U.S.C. §116 and 37 C.F.R. §1.47(a) under the circumstances that one of the joint inventors, Hua Shen, now refuses to join in the above-identified patent application. The available joint inventors, Jingyu Lian, David Kotecki, Robert Laibowitz, Katherine Saenger, Chenting Lin, Nicolas Nagel, Yunyu Wang, Satish D. Athavale, and Thomas Shaw, have executed the Declaration on their own behalf and on behalf of the non-signing joint inventor, as indicated by the signature block of the non-signing inventor being left blank.

The enclosed Declaration in Support of Petition Under 37 C.F.R. 1.47(a), and the accompanying documentary evidence meet the requirement set forth in 35 U.S.C. § 116, 37 C.F.R. § 1.47(a) and M.P.E.P. § 409.03 to provide proof that the non-signing inventor refuses to

**REISSUE APPLICATION OF SMALLCOMB ET AL.
APPLICATION SERIAL NO. 09/927,778
PAGE 2 OF 2**

execute the application papers.

The last known address of the non-signing joint inventor is:

Hua Shen
c/o xilinx, Inc.
2100 Logic Drive
San Jose, CA 95124

Your petitioners therefore respectfully request that, pursuant to 35 U.S.C. 116 and 37 C.F.R. 1.47(a), the above-identified application be accepted for examination.

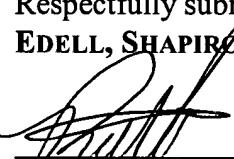
A check in the amount of \$130 is enclosed in payment of the required petition fee (37 C.F.R. § 1.17(h)). Applicants hereby petition for any extension of time which may be required to maintain the pendency of this case, and any required fee for such extension or any other fee required to maintain the pendency of this case is to be charged to Deposit Account No. 05-0460.

Dated: 4/24/04

EDELL, SHAPIRO & FINNAN, LLC
CUSTOMER No. 27896
1901 Research Boulevard, Suite 400
Rockville, MD 20850
(301) 424-3640

By:

Respectfully submitted by
EDELL, SHAPIRO & FINNAN, LLC



Patrick J. Finnegan
Reg. No. 39,189



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/790,786
Applicant : Jingyu Lian, et al.
Filed : March 3, 2004
TC/A.U. : Not Yet Assigned
Examiner : Unknown
Confirmation No. : 4369
Docket No. : 0928.0067C
Customer No. : 27896
Title : Method for Forming A (III) Oriented BSTO Thin Film Layer for High Dielectric Constant Capacitors

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

DECLARATION IN SUPPORT OF PETITION UNDER 37 C.F.R. 1.47(a)

Sir:

I, Patrick J. Finn, declare as follows:

I am an attorney, registered to practice before the U.S. Patent and Trademark Office, who is handling Application Serial No. 10/790,786 filed on March 3, 2004 for the invention entitled "Method for Forming A (III) Oriented BSTO Thin Film Layer for High Dielectric Constant Capacitors," and have firsthand knowledge of the facts and events relating to the refusal of the inventor, Hua Shen, to join in this reissue application of the subject invention by refusing to execute the application Declaration required under 37 C.F.R. §1.51, §1.63 and §1.175.

I hereby aver that Jingyu Lian, David Kotecki, Robert Laibowitz, Katherine Saenger, Chenting Lin, Nicolas Nagel, Yunyu Wang, Satish D. Athavale, Thomas Shaw, and Hua Shen invented the subject matter disclosed in the application. Jingyu Lian, David Kotecki, Robert Laibowitz, Katherine Saenger, Chenting Lin, Nicolas Nagel, Yunyu Wang, Satish D. Athavale, and Thomas Shaw executed the original application Declaration stating that they are joint

inventors and that they have reviewed and understood the contents of the application, including the specification and claims. (See Appendix A). Ms. Shen has never executed a previous Declaration.

On September 10, 2004, I sent a letter via USPS, Certified Return Receipt Requested to Ms. Shen relating to executing for an application Declaration for the instant application. (Appendix B) at her last-known address: Hua Shen, c/o xilinx, Inc., 2100 Logic Drive, San Jose, CA 95124. Attached to the letter was a Declaration for execution and a copy of the application as filed. The letter explained that the executed Declaration needed to be filed in the U.S. Patent and Trademark Office in order to be accepted for examination. The letter requested Ms. Shen to sign and date the declaration, and to return the declaration to me.

On September 22, 2004, I received the return receipt card indicating Ms. Shen had received the documents (Appendix C). Ms. Shen apparently continues to refuse to sign a Declaration.

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

**U.S. PATENT APPLICATION OF JINGYU LIAN, ET AL.
APPLICATION SERIAL NO. 10/790,786
PAGE 3 OF 3**

Dated: 9/24/04

**EDELL, SHAPIRO & FINNAN, LLC
CUSTOMER No. 27896
1901 Research Boulevard, Suite 400
Rockville, MD 20850
(301) 424-3640**

By:

Respectfully submitted by
EDELL, SHAPIRO & FINNAN, LLC



Patrick J. Finnegan
Reg. No. 39,189



Serial No. NOT YET ASSIGNED
Infineon Docket No. 2003 P
53234 US
OC Docket No. INF-109

**DECLARATION FOR PATENT APPLICATION, POWER OF
ATTORNEY & DESIGNATION OF CORRESPONDENCE ADDRESS**

As below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**METHOD FOR FORMING A (111) ORIENTED BSTO THIN FILM LAYER FOR HIGH
DIELECTRIC CONSTANT CAPACITORS**

the specification of which (check one)

is attached hereto.

was filed on _____ as Application Serial No. _____
and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me to be material to the patentability of this application in accordance with 37 CFR §1.56(a).

**PRIOR FOREIGN/PCT APPLICATION(S) FILED WITHIN 12 MONTHS (6 MONTHS FOR
DESIGN) PRIOR TO THIS APPLICATION AND ANY PRIORITY CLAIMS UNDER 35
U.S.C. § 119(a)-(d)**

I hereby claim foreign priority benefits under 35 USC § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
Number	Country	Day/Month/Year Filed	Yes	No

CLAIM FOR BENEFIT OF PRIOR U.S. PROVISIONAL APPLICATION(S)

Serial No. NOT 2 YET ASSIGNED
Infineon Docket No. 2003 P 52345
US
OC Docket No. INF-109

(35 U.S.C. § 119(e))

I hereby claim the benefit under Title 35, United States Code, § 119 (e) of any United States provisional application(s) listed below:

Provisional Application Number	Filing Date

**CLAIM FOR BENEFIT OF EARLIER US/PCT APPLICATION(S)
UNDER 35 U.S.C. § 120**

I hereby claim the benefits under 35 USC § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 USC § 112, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Appl. No.	Filing Date	Patented, Pending, Abandoned

Power of Attorney: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Erik O. Berger, Reg. No. 42,315; Stanton C. Braden, Reg. No. 32,556; Marie-Claire B. Maple, Reg. No. 37,588; Lawrence J. Gotts, Reg. No. 31,163, Michael D. Bednarek, Reg. No. 32,329, Aslan Baghdadi, Reg. No. 34,542, Elizabeth M. Roesel, Reg. No. 34,878, David C. Isaacson, Reg. No. 38,500, Lawrence D. Eisen, Reg. No. 41,009, Michael A. Oblon, Reg. No. 42,956, Steven P. Arnheim, Reg. No. 43,475, Poh C. Chua, Reg. No. 44,615, Michelle S. Marks, Reg. No. 41,971, Joanne H. Kim, Reg. No. 51,193, Chad D. Wells, Reg. No. 50,875, Brett C. Martin, Reg. No. 52,000

Send correspondence to:

SHAW PITTMAN LLP
1650 Tysons Boulevard
McLean, VA 22102-4859
(703) 790-7900

Direct telephone calls to:

Michael A. Oblon (703) 770-7645

I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under

further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor:	Jingyu LIAN
Inventor's Signature:	
Date:	12-9-03
Residence:	Wallkill, New York 12589
Citizenship:	United States
Mailing Address:	6 Libra Lane, Wallkill, New York 12589

Full Name of Second Inventor:	David KOTECKI
Inventor's Signature:	
Date:	
Residence:	Orono, Maine
Citizenship:	United States
Mailing Address:	55 College Avenue, Orono, Maine 04473

Full Name of Third Inventor:	Hua SHEN
Inventor's Signature:	
Date:	
Residence:	San Jose, California
Citizenship:	China
Mailing Address:	c/o Xilinx, Inc., 2100 Logic Drive, San Jose, California 95124

Full Name of Fourth Inventor:	Robert LAIBOWITZ
Inventor's Signature:	
Date:	
Residence:	Cortland Manor, New York
Citizenship:	United States
Mailing Address:	407 Furnace Dock Road, Cortland Manor, New York 10567

Full Name of Fifth Inventor:	Katherine SAENGER
Inventor's Signature:	
Date:	
Residence:	Ossining, New York
Citizenship:	United States
Mailing Address:	115 Underhill Road, Ossining, New York 10562

Serial No. NOT 3 YET ASSIGNED
Infineon Docket No. 2003 P 52345
US
OC Docket No. INF-109

18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor: Jingyu LIAN	
Inventor's Signature:	Date:
Residence: Wallkill, New York 12589	
Citizenship: United States	
Mailing Address: 6 Libra Lane, Wallkill, New York 12589	

Full Name of Second Inventor: David KOTECKI	
Inventor's Signature: 	Date: 12/17/03
Residence: Orono, Maine	
Citizenship: United States	
Mailing Address: 55 College Avenue, Orono, Maine 04473	

Full Name of Third Inventor: Hua SHEN	
Inventor's Signature:	Date:
Residence: San Jose, California	
Citizenship: China	
Mailing Address: c/o Xilinx, Inc., 2100 Logic Drive, San Jose, California 95124	

Full Name of Fourth Inventor: Robert LAIBOWITZ	
Inventor's Signature:	Date:
Residence: Cortland Manor, New York	
Citizenship: United States	
Mailing Address: 407 Furnace Dock Road, Cortland Manor, New York 10567	

Serial No. NOT YET ASSIGNED
 Infineon Docket No. 2003 P 52345
 US
 OC Docket No. INF-109

Full Name of Sixth Inventor: Chenting LIN	
Inventor's Signature:	Date:
Residence: Poughkeepsie, New York	
Citizenship: Taiwan	
Mailing Address: 15 Coachlight Drive, Poughkeepsie, New York 12605	

Full Name of Seventh Inventor: Nicolas NAGEL	
Inventor's Signature:	Date:
Residence: Dresden, Germany	
Citizenship: Germany	
Mailing Address: Koenigsbuecker strasse 180, 01099 Dresden, Germany	

Full Name of Eighth Inventor: Yunyu WANG	
Inventor's Signature: <i>Yunyu Wang</i>	Date: 12/9/03
Residence: Poughquag, New York	
Citizenship: United States	
Mailing Address: 145 C. Cypher Lane, Poughquag, New York 12570	

Full Name of Ninth Inventor: Satish D. ATHAVALE	
Inventor's Signature:	Date:
Residence: Fishkill, New York	
Citizenship: India	
Mailing Address: 111 Elmcrest Drive, Fishkill, New York 12524	

Full Name of Tenth Inventor: Thomas SHAW	
Inventor's Signature:	Date:
Residence: Peekskill, New York	
Citizenship: United Kingdom	
Mailing Address: 1210 Elm Street, Peekskill, New York 10566	

further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor: Jingyu LIAN	
Inventor's Signature:	Date:
Residence: Wallkill, New York 12589	
Citizenship: United States	
Mailing Address: 6 Libra Lane, Wallkill, New York 12589	

Full Name of Second Inventor: David KOTECKI	
Inventor's Signature:	Date:
Residence: Orono, Maine	
Citizenship: United States	
Mailing Address: 55 College Avenue, Orono, Maine 04473	

Full Name of Third Inventor: Hua SHEN	
Inventor's Signature:	Date:
Residence: San Jose, California	
Citizenship: China	
Mailing Address: c/o Xilinx, Inc., 2100 Logic Drive, San Jose, California 95124	

Full Name of Fourth Inventor: Robert LAIBOWITZ	
Inventor's Signature: <i>Robert Laibowitz</i>	Date: 12/12/03
Residence: Cortland Manor, New York	
Citizenship: United States	
Mailing Address: 407 Furnace Dock Road, Cortland Manor, New York 10567	

Full Name of Fifth Inventor: Katherine SAENGER	
Inventor's Signature: <i>Katherine Saenger</i>	Date: 12/10/03
Residence: Ossining, New York	
Citizenship: United States	
Mailing Address: 115 Underhill Road, Ossining, New York 10562	

Serial No. NOT YET ASSIGNED
 Infineon Docket No. 2003 P 52345
 US
 OC Docket No. INF-109

Full Name of Sixth Inventor: Chenting LIN	
Inventor's Signature:	Date:
Residence: Poughkeepsie, New York	
Citizenship: Taiwan	
Mailing Address: 15 Coachlight Drive, Poughkeepsie, New York 12605	

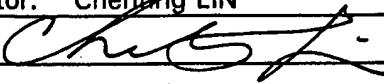
Full Name of Seventh Inventor: Nicolas NAGEL	
Inventor's Signature:	Date:
Residence: Dresden, Germany	
Citizenship: Germany	
Mailing Address: Koenigsbuecker strasse 180, 01099 Dresden, Germany	

Full Name of Eighth Inventor: Yunyu WANG	
Inventor's Signature:	Date:
Residence: Poughquag, New York	
Citizenship: United States	
Mailing Address: 145 C. Cypher Lane, Poughquag, New York 12570	

Full Name of Ninth Inventor: Satish D. ATHAVALE	
Inventor's Signature:	Date:
Residence: Fishkill, New York	
Citizenship: India	
Mailing Address: 111 Elmcrest Drive, Fishkill, New York 12524	

Full Name of Tenth Inventor: Thomas SHAW	
Inventor's Signature: <i>Thomas Shaw</i>	Date: 12/10/03
Residence: Peekskill, New York	
Citizenship: United Kingdom	
Mailing Address: 1210 Elm Street, Peekskill, New York 10566	

Serial No. NOT YET ASSIGNED
Infineon Docket No. 2003 P 52345
US
OC Docket No. INF-109

Full Name of Sixth Inventor:	Chenting LIN
Inventor's Signature:	
Date:	12/9/03
Residence:	Poughkeepsie, New York
Citizenship:	Taiwan USA
Mailing Address:	15 Coachlight Drive, Poughkeepsie, New York 12605

Full Name of Seventh Inventor:	Nicolas NAGEL
Inventor's Signature:	
Date:	
Residence:	Dresden, Germany
Citizenship:	Germany
Mailing Address:	Koenigsbuecker strasse 180, 01099 Dresden, Germany

Full Name of Eighth Inventor:	Yunyu WANG
Inventor's Signature:	
Date:	
Residence:	Poughquag, New York
Citizenship:	United States
Mailing Address:	145 C. Cypher Lane, Poughquag, New York 12570

Full Name of Ninth Inventor:	Satish D. ATHAVALE
Inventor's Signature:	
Date:	
Residence:	Fishkill, New York
Citizenship:	India
Mailing Address:	111 Elmcrest Drive, Fishkill, New York 12524

Full Name of Tenth Inventor:	Thomas SHAW
Inventor's Signature:	
Date:	
Residence:	Peekskill, New York
Citizenship:	United Kingdom
Mailing Address:	1210 Elm Street, Peekskill, New York 10566

Serial No. NOT YET ASSIGNED
 Infineon Docket No. 2003 P 52345
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Full Name of Sixth Inventor: Chenting LIN	
Inventor's Signature: 	Date:
Residence: Poughkeepsie, New York	
Citizenship: Taiwan	
Mailing Address: 15 Coachlight Drive, Poughkeepsie, New York 12605	

Full Name of Seventh Inventor: Nicolas NAGEL	
Inventor's Signature: 	Date: 18 Dec 2003
Residence: Dresden, Germany	
Citizenship: Germany	
Mailing Address: Koenigsbuecker strasse 180, 01099 Dresden, Germany	

Full Name of Eighth Inventor: Yunyu WANG	
Inventor's Signature:	Date:
Residence: Poughquag, New York	
Citizenship: United States	
Mailing Address: 145 C. Cypher Lane, Poughquag, New York 12570	

Full Name of Ninth Inventor: Satish D. ATHAVALE	
Inventor's Signature:	Date:
Residence: Fishkill, New York	
Citizenship: India	
Mailing Address: 111 Elmcrest Drive, Fishkill, New York 12524	

Full Name of Tenth Inventor: Thomas SHAW	
Inventor's Signature:	Date:
Residence: Peekskill, New York	
Citizenship: United Kingdom	
Mailing Address: 1210 Elm Street, Peekskill, New York 10566	

Inventor's Signature:	Date:
Residence: Ossining, New York	
Citizenship: United States	
Mailing Address: 115 Underhill Road, Ossining, New York 10562	

Full Name of Sixth Inventor: Chenting LIN	
Inventor's Signature:	Date:
Residence: Poughkeepsie, New York	
Citizenship: Taiwan	
Mailing Address: 15 Coachlight Drive, Poughkeepsie, New York 12605	

Full Name of Seventh Inventor: Nicolas NAGEL	
Inventor's Signature:	Date:
Residence: Dresden, Germany	
Citizenship: Germany	
Mailing Address: Koenigsbuecker strasse 180, 01099 Dresden, Germany	

Full Name of Eighth Inventor: Yunyu WANG	
Inventor's Signature:	Date:
Residence: Poughquag, New York	
Citizenship: United States	
Mailing Address: 145 C. Cypher Lane, Poughquag, New York 12570	

Full Name of Ninth Inventor: Satish D. ATHAVALE	
Inventor's Signature: <i>Sathavale</i>	Date: Dec. 17, 2003
Residence: Fishkill, New York	
Citizenship: India	
Mailing Address: 111 Elmcrest Drive, Fishkill, New York 12524	

Full Name of Tenth Inventor: Thomas SHAW	
Inventor's Signature:	Date:
Residence: Peekskill, New York	
Citizenship: United Kingdom	

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EDELL, SHAPIRO & FINNAN, LLC

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WESLEY W. MULLER
AISHA AHMAD

* VA BAR ◊ WI BAR
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September 10, 2004

Via Certified Mail

Ms. Hua Shen
c/o xilinx, Inc.
2100 Logic Drive
San Jose, CA 95124

Re: U.S. Patent Application Serial No. 10/790,786
Method for Forming a (111) Oriented BSTO Thin Film Layer for
High Dielectric Constant Capacitors
Infineon Ref: 2003P53234 US; Our Ref.: 0928.0067C

Dear Ms. Shen:

We recently took over representation of the above-identified patent application from Shaw Pittman, LLP on behalf of Infineon Technologies North America Corp.

Enclosed for your execution are a Declaration and Power of Attorney, an Assignment and a copy of U.S. Patent Application Serial No. 10/790,786. Please sign the Declaration and Assignment documents and return them to us in the enclosed FedEx envelope immediately, so that they may be timely filed in the U.S. Patent and Trademark Office.

U.S. Postal Service™
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Total Postage & Fees	\$ 5.80

9/10/04
Postmark Here

Sent To: Hua Shen c/o xilinx, Inc.
Street, Apt. No.,
or PO Box No.
City, State, Zip+4
PS Form 3800, June 2002
See Reverse for Instructions

ly questions, concerns or comments relating to the

Sincerely,

Patrick J. Finnegan

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SENDER: COMPLETE THIS SECTION

- Complete items 1, 2, and 3. Also complete item 4 if Restricted Delivery is desired.
- Print your name and address on the reverse so that we can return the card to you.
- Attach this card to the back of the mailpiece, or on the front if space permits.

1. Article Addressed to:

Ms. Hua Shen
c/o Xilinx, Inc.
2100 Logic Drive
San Jose, CA
95124

2. Article Number

(Transfer from service label)

7003 1680 0001 4005 5048

PS Form 3811, August 2001

Domestic Return Receipt

102595-02-M-1540

COMPLETE THIS SECTION ON DELIVERY

A. Signature

X

Agent

Addressee

B. Received by (Printed Name)

MS. HUA SHEN

C. Date of Delivery

D. Is delivery address different from item 1? Yes

If YES, enter delivery address below:

No

3. Service Type

Certified Mail

Express Mail

Registered

Return Receipt for Merchandise

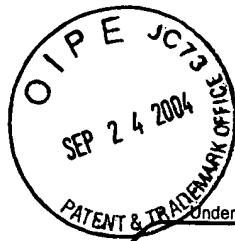
Insured Mail

C.O.D.

4. Restricted Delivery? (Extra Fee)

Yes

0928.0047C



PTO/SB/82 (09-03)
Approved for use through 11/30/2005. OMB 0651-0035
U.S. Patent and Trademark Office, U.S. DEPARTMENT OF COMMERCE
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**REVOCATION OF POWER OF
ATTORNEY WITH
NEW POWER OF ATTORNEY
AND
CHANGE OF CORRESPONDENCE ADDRESS**

Application Number	10/790,786
Filing Date	March 3, 2004
First Named Inventor	Jingyu Lian, et al.
Art Unit	Unknown
Examiner Name	Unknown
Attorney Docket Number	0928.0067C

I hereby revoke all previous powers of attorney given in the above-identified application.

A Power of Attorney is submitted herewith.

OR

I hereby appoint the practitioners associated with the Customer Number:

Please change the correspondence address for the above-identified application to:

The address associated with
Customer Number:

27896

OR

<input type="checkbox"/> Firm or Individual Name			
Address			
Address			
City		State	Zip
Country			
Telephone		Fax	

I am the:

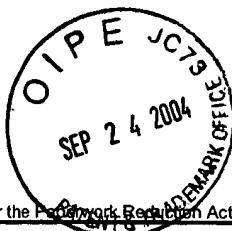
- Applicant/Inventor.
 Assignee of record of the entire interest. See 37 CFR 3.71.
Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96)

SIGNATURE of Applicant or Assignee of Record

Name	Michael Kucher, for Infineon Technologies North America Corp., Its Assistant Secretary Duly Authorized		
Signature			
Date	September 16, 2004	Telephone	919-677-7101
NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.			
<input type="checkbox"/> *Total of _____ forms are submitted.			

This collection of information is required by 37 CFR 1.36. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 3 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance in completing the form, call 1-800-PTO-9199 and select option 2.



Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

PTO/SB/82 (09-03)

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Application Number	10/790,786
Filing Date	March 3, 2004
First Named Inventor	Jingyu Lian, et al.
Art Unit	Unknown
Examiner Name	Unknown
Attorney Docket Number	0928.0067C

I hereby revoke all previous powers of attorney given in the above-identified application.

A Power of Attorney is submitted herewith.

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I hereby appoint the practitioners associated with the Customer Number:

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I am the:

Applicant/Inventor.

Assignee of record of the entire interest. See 37 CFR 3.71.
Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96)

SIGNATURE of Applicant or Assignee of Record

Name	Lynne D. Anderson, Program Manager, US Patent Office Liaison		
Signature			
Date	September 21, 2004	Telephone	(703)299-1455

NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below*.

*Total of _____ forms are submitted.

This collection of information is required by 37 CFR 1.36. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 3 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.